

MMC AND SD CARD VOLTAGE-TRANSLATION TRANSCEIVER

FEATURES

- Transceiver for Memory Card Interface [MultiMediaCard (MMC) and Secure Digital (SD) Compliant Products]
- Configurable I/O Switching Levels With Dual-Supply Pins Operating Over Full 1.2-V to 3.6-V Power-Supply Range
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection
 - ±8-kV Contact Discharge
 - ±15-kV Air-Gap Discharge
- EMI Filtering
- Integrated Pullup and Pulldown Resistors on Card-Side I/Os per SD Specification
- ZQS Package Has 100-kΩ Pullup Resistors Via WP and CD Pins

DESCRIPTION/ORDERING INFORMATION

The SN74AVCA406E is a transceiver for interfacing microprocessors with MultiMediaCards (MMCs) and secure digital (SD) cards.

Two supply-voltage pins allow the A-port and B-port input switching thresholds to be configured separately. The A port is designed to track V_{CCA} , while the B port is designed to track V_{CCB} . V_{CCA} and V_{CCB} can accept any supply voltage from 1.2 V to 3.6 V.

If either V_{CC} is switched off ($V_{CCA} = 0 \text{ V}$ and/or $V_{CCB} = 0 \text{ V}$), all outputs are placed in the high-impedance state to conserve power.

The SN74AVCA406E enables system designers to easily interface low-voltage microprocessors to different memory cards operating at higher voltages.

Memory card standards recommend high ESD protection for devices that connect directly to the external memory card. To meet this need, the SN74AVCA406E incorporates ±15-kV Air-Gap Discharge and ±8-kV Contact Discharge protection on the card side.

The SN74AVCA406E is available in two 0.5-mm-pitch ball grid array (BGA) packages. The 20-ball package has dimensions of 3 mm × 2.5 mm, and the 24-ball package measures 3 mm × 3 mm. Memory cards are widely used in mobile phones, PDAs, digital cameras, personal media players, camcorders, set-top boxes, etc. Low static power consumption and small package size make the SN74AVCA406E an ideal choice for these applications.

ORDERING INFORMATION

| T _A | PACKAGE ⁽¹⁾⁽²⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|---------------------------------------|--------------|-----------------------|------------------|
| | UFBGA – ZXY (Pb-Free) | Reel of 2500 | SN74AVCA406EZXYR | WM406E |
| -40°C to 85°C | MicroStar Junior™ BGA – ZQS (Pb-Free) | Reel of 2500 | SN74AVCA406EZQSR | WM406E |

⁽¹⁾ Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

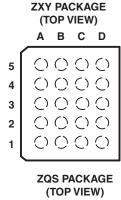


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

MicroStar Junior is a trademark of Texas Instruments.

⁽²⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.





TERMINAL ASSIGNMENTS (20-Ball ZXY Package)

| | Α | В | С | D |
|---|------------------|---------|------------|------------------|
| 5 | V _{CCA} | CMD-dir | DAT0-dir | V _{CCB} |
| 4 | DAT3A | DAT2A | DAT2B | DAT3B |
| 3 | CLKA | GND | GND | CLKB |
| 2 | DAT1A | DAT0A | CMDB | DAT0B |
| 1 | CLK-f | CMDA | DAT123-dir | DAT1B |

TERMINAL ASSIGNMENTS (24-Ball ZQS Package)

| | 1 | 2 | 3 | 4 | 5 |
|---|-------|---------|------------|-----------|-------|
| Α | DAT2A | CMD-dir | DAT0-dir | RSV | DAT2B |
| В | DAT3A | | V_{CCA} | V_{CCB} | DAT3B |
| С | CLKA | RSV | GND | GND | CLKB |
| D | DAT0A | CMDA | CD | CMDB | DAT0B |
| Е | DAT1A | CLK-f | DAT123-dir | WP | DAT1B |

REFERENCE DESIGN

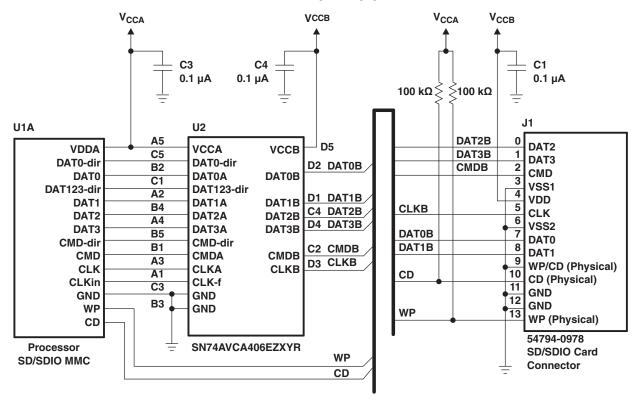


Figure 1. Interfacing With SD/SDIO Card



PIN DESCRIPTION

| ZQS ZXY | | | | | | |
|----------|----------|------------------|---|--------|--|--|
| BALL NO. | BALL NO. | NAME | FUNCTION | TYPE | | |
| A1 | B4 | DAT2A | Data bit 3 connected to host. Referenced to V _{CCA} . | I/O | | |
| A2 | B5 | CMD-dir | Direction control for command bit (CMDA/CMDB) | Input | | |
| А3 | C5 | DAT0-dir | Direction control for DAT0A/DAT0B | Input | | |
| A4, C2 | - | RSV | Reserved (for possible future functionality). Leave unconnected. | | | |
| A5 | C5 | DAT2B | Data bit 3 connected to memory card. Includes a 70-kΩ pullup resistor to V _{CCB} . | I/O | | |
| B1 | A4 | DAT3A | Data bit 4 connected to host. Referenced to V _{CCA} . | I/O | | |
| B2 | - | _ | Depopulated ball | | | |
| В3 | A5 | V _{CCA} | A-port supply voltage. V _{CCA} powers all A-port I/Os and control inputs. | Power | | |
| B4 | D5 | V _{CCB} | B-port supply voltage. V _{CCB} powers all B-port I/Os. | Power | | |
| B5 | D4 | DAT3B | Data bit 4 connected to memory card. Includes a 470-k Ω pulldown resistor to V_{CCB} . | I/O | | |
| C1 | А3 | CLKA | Clock signal connected to host. Referenced to V _{CCA} . | Input | | |
| C3 | В3 | GND | Ground | | | |
| C4 | C3 | GND | Ground | | | |
| C5 | D3 | CLKB | Clock signal connected to memory card. Referenced to V _{CCB} . | Output | | |
| D1 | B2 | DAT0A | Data bit 1 connected to host. Referenced to V _{CCA} . | I/O | | |
| D2 | B1 | CMDA | Command bit connected to host. Referenced to V _{CCA} . | I/O | | |
| D3 | _ | CD | Connected to card detect on the mechanical connector. CD has an internal 100-k Ω pullup resistor to V _{CCA} and this pin has ±10-kV Air-Gap Discharge and ±8-kV Contact Discharge ESD protection. | Output | | |
| D4 | C2 | CMDB | Command bit connected to memory card. Includes a 15-k Ω pullup resistor to V_{CCB} . | I/O | | |
| D5 | D2 | DAT0B | Data bit 1 connected to memory card. Includes a 70-kΩ pullup resistor to V _{CCB} . | I/O | | |
| E1 | A2 | DAT1A | Data bit 2 connected to host. Referenced to V _{CCA} . | I/O | | |
| E2 | A1 | CLK-f | Clock feedback to host for resynchronizing data. Used in OMAP processors. Leave unconnected if not used. | Output | | |
| E3 | C1 | DAT123-dir | Direction control for DAT1A/B, DAT2A/B, and DAT3A/B | Input | | |
| E4 | _ | WP | Connected to write protect on the mechanical connector. WP has an internal 100-k Ω pullup resistor to V _{CCA} and this pin has ±10-kV Air-Gap Discharge and ±8-kV Contact Discharge ESD protection. | Output | | |
| E5 | D1 | DAT1B | Data bit 2 connected to memory card. Includes a 70-kΩ pullup resistor to V _{CCB} . | I/O | | |



FUNCTION TABLES

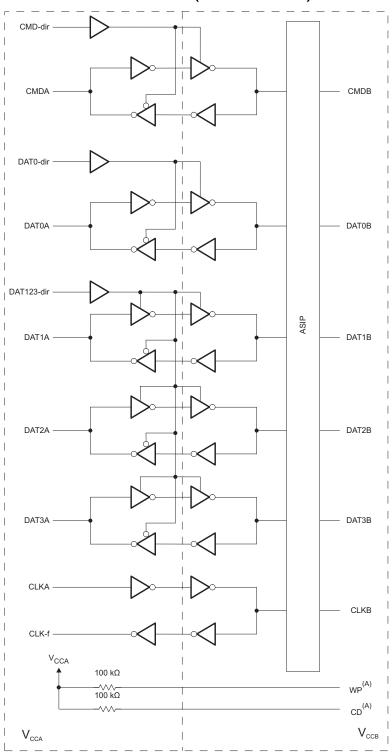
| CONTROL INPUT | OUTPUT | OPERATION | |
|---------------|---------|-----------|--------------|
| CMD-dir | CMDA | CMDB | OPERATION |
| High | Hi-Z | Enabled | CMDA to CMDB |
| Low | Enabled | Hi-Z | CMDB to CMDA |

| CONTROL INPUT | OUTPUT | FUNCTION | |
|---------------|---------|----------|----------------|
| DAT0-dir | DAT0A | DAT0B | FUNCTION |
| High | Hi-Z | Enabled | DAT0A to DAT0B |
| Low | Enabled | Hi-Z | DAT0B to DAT0A |

| | OUTPUT | | |
|-----------------------------|----------------------------------|---------|----------------|
| CONTROL INPUT DAT123-dir | DAT1A, DAT1B, DAT2B, DAT3A DAT3B | | FUNCTION |
| | | | DAT1A to DAT1B |
| High | Hi-Z | Enabled | DAT2A to DAT2B |
| | | | DAT3A to DAT3B |
| | | | DAT1B to DAT1A |
| Low | Enabled | Hi-Z | DAT2B to DAT2A |
| | | | DAT3B to DAT3A |



LOGIC DIAGRAM (POSITIVE LOGIC)



A. WP and CD pullup resistors are for the ZQS package only.

Figure 2. Logic Diagram



BLOCK DIAGRAM

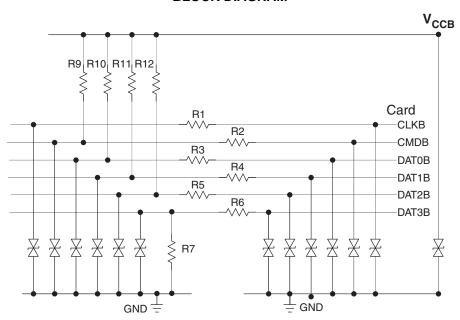
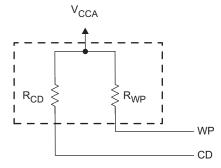


Figure 3. ASIP Block Diagram

| RESISTORS | | BIDIRECTIONAL | ZENER DIODES |
|------------------------|--------|------------------|--------------|
| R1, R2, R3, R4, R5, R6 | | Vbr min. | 14 V at 1 mA |
| | 40 Ω | Line capacitance | <20 pF |
| Tolerance | ±20% | | |
| R10, R11, R12 | 70 kΩ | | |
| R9 | 15 kΩ | | |
| R7 | 470 kΩ | | |
| Tolerance | ±30% | | |



| Resistors | |
|-----------------------------------|--------|
| R _{WP} , R _{CD} | 100 kΩ |
| Tolerance | ±30% |

Figure 4. WP, CD Pullup Resistors (for ZQS Package Only)



ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT | |
|------------------|---|--------------------|---|--|------|--|
| V _{CCA} | Supply voltage range | | -0.5 | 4.6 | V | |
| | | I/O ports (A port) | -0.5 | 4.6 | | |
| V_{I} | Input voltage range ⁽²⁾ | I/O ports (B port) | -0.5 | 4.6 | V | |
| | | Control inputs | -0.5 | 4.6 4.6 4.6 4.6 4.6 4.6 4.6 5 V _{CCA} + 0.5 V _{CCB} + 0.5 -50 -50 ±50 ±100 | | |
| \/ | Voltage range applied to any output | A port | -0.5 | 4.6 | V | |
| Vo | in the high-impedance or power-off state (2) | B port | -0.5 | 4.6 4.6 4.6 4.6 4.6 4.6 V _{CCA} + 0.5 V _{CCB} + 0.5 -50 -50 ±50 ±100 | v | |
| 1/ | Veltage range applied to any output in the high or law state (2)(3) | A port | -0.5 | V _{CCA} + 0.5 | V | |
| Vo | Voltage range applied to any output in the high or low state (2)(3) | B port | -0.5 4.6 -0.5 4.6 -0.5 4.6 -0.5 4.6 -0.5 4.6 -0.5 V _{CCA} + 0.5 -0.5 V _{CCB} + 0.5 -50 ±50 ±100 | V | | |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA | |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA | |
| Io | Continuous output current | · | | ±50 | mA | |
| | Continuous current through V _{CCA} , V _{CCB} , or GND | | | ±100 | mA | |
| T _{stg} | Storage temperature range | | -65 | 150 | °C | |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

PACKAGE THERMAL IMPEDANCE

| | | | UNIT | |
|---------------|--|-------------|-------|-------|
| 0 | Dealers thermal impedance (1) | ZQS package | 171.6 | °C/W |
| θ_{JA} | P _{JA} Package thermal impedance ⁽¹⁾ | ZXY package | 193 | *C/VV |

(1) The package thermal impedance is calculated in accordance with JESD 51-7.

⁽²⁾ The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.



RECOMMENDED OPERATING CONDITIONS (1)(2)(3)

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------|------------------------------------|---------------------------|------------------|------------------|-------------------------|---|------|
| V_{CCA} | Supply voltage | | | | 1.2 | 3.6 | V |
| V_{CCB} | Supply voltage | | | | 1.2 | 3.6 | V |
| | | | 1.2 V to 1.95 V | | V _{CCI} x 0.65 | | V |
| V_{IH} | High-level input voltage | All inputs (4) | 1.95 V to 2.7 V | | 1.7 | | |
| | | | 2.7 V to 3.6 V | | 2 | 1.2 3.6 1.2 3.6 0.65 1.7 | |
| | | | 1.2 V to 1.95 V | | | V _{CCI} x 0.35 | |
| V_{IL} | Low-level input voltage | All inputs ⁽⁴⁾ | 1.95 V to 2.7 V | | | 0.7 | V |
| | | | 2.7 V to 3.6 V | | | 0.8 | |
| VI | Input voltage | Control inputs | | | 0 | 3.6 | V |
| ., | | Active state | | | 0 | V _{cco} | ., |
| V _{I/O} | Input/output voltage | 3-state | | | 0 | | V |
| | | | | 1.2 V | | -1 | |
| | | | 1.4 V to 1.6 V | | -1 | | |
| I_{OH} | High-level output current (A port) | | | 1.65 V to 1.95 V | | -2 | mA |
| | | | | 2.3 V to 2.7 V | | -4 | |
| | | | | 3 V to 3.6 V | | -8 | |
| | | | | 1.2 V | | 1 | |
| | | | | 1.4 V to 1.6 V | | 1 | |
| I_{OL} | Low-level output current (| (A port) | | 1.65 V to 1.95 V | | 2 | mA |
| 2.7 \to 3.6 \to | 2.3 V to 2.7 V | | 4 | | | | |
| | | | | 3 V to 3.6 V | | 1.7 2 V _{CCI} x 0.35 0.7 0.8 0 3.6 0 V _{CCO} 0 3.6 -1 -1 -1 -2 -4 -8 1 1 2 4 8 -16 1 2 4 8 16 | |
| | | | | 1.2 V | | -1 | |
| | | | | 1.4 V to 1.6 V | | -2 | |
| I_{OH} | High-level output current | (B port) | | 1.65 V to 1.95 V | | -4 | mA |
| | | | | 2.3 V to 2.7 V | | -8 | |
| | | | | 3 V to 3.6 V | | -16 | |
| | | | | 1.2 V | | 1 | |
| | | | | 1.4 V to 1.6 V | | 2 | |
| I_{OL} | Low-level output current (| (B port) | | 1.65 V to 1.95 V | | 4 | mA |
| | | | | 2.3 V to 2.7 V | | 8 | |
| | | | | 3 V to 3.6 V | | 16 | |
| Δt/Δν | Input transition rise or fall | rate | | | | 5 | ns/V |
| T _A | Operating free-air temper | ature | | | -40 | 85 | °C |

 V_{CCI} is the V_{CC} associated with the input port. V_{CCO} is the V_{CC} associated with the output port. (2)

 ⁽³⁾ All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
 (4) CMD-dir, DAT0-dir, and DAT123-dir are referenced to V_{CCA}.



ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) $^{(1)(2)}$

| PA | RAMETER | TEST CONDITIONS I _{OH} = -100 μA | | V _{CCA} | V _{CCB} | MIN | TYP ⁽³⁾ | MAX | UNIT |
|--------------------------------|------------------|---|--|------------------|------------------|------------------------|--------------------|------|------|
| | | $I_{OH} = -100 \mu A$ | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | V _{CCO} - 0.2 | | | |
| | | $I_{OH} = -1 \text{ mA}$ | | 1.2 V | 1.2 V | | 0.9 | | |
| . , | At | $I_{OH} = -1 \text{ mA}$ | ., ., | 1.4 V | 1.4 V | 1.05 | | | ., |
| V _{OH} | A port | $I_{OH} = -2 \text{ mA}$ | $V_I = V_{IH}$ | 1.65 V | 1.65 V | 1.2 | | | V |
| | | $I_{OH} = -4 \text{ mA}$ | | 2.3 V | 2.3 V | 1.75 | | | |
| | | $I_{OH} = -8 \text{ mA}$ | | 3 V | 3 V | 2.3 | | | |
| | | $I_{OL} = 100 \mu A$ | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | 0.2 | |
| | | I _{OL} = 1 mA | | 1.2 V | 1.2 V | | 0.1 | | |
| ., | At | I _{OL} = 1 mA | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | 1.4 V | 1.4 V | | | 0.35 | V |
| V_{OL} | A port | I _{OL} = 2 mA | $V_I = V_{IL}$ | 1.65 V | 1.65 V | | | 0.45 | V |
| | | I _{OL} = 4 mA | | 2.3 V | 2.3 V | | | 0.55 | |
| | | I _{OL} = 8 mA | | 3 V | 3 V | | | 0.7 | |
| | | $I_{OH} = -100 \mu A$ | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | V _{CCO} - 0.2 | | | |
| | | $I_{OH} = -1 \text{ mA}$ | | 1.2 V | 1.2 V | | 1.1 | | |
| . , | | $I_{OH} = -2 \text{ mA}$ | ., ., | 1.4 V | 1.4 V | 1.05 | | | |
| V_{OH} | B port | $I_{OH} = -4 \text{ mA}$ | $V_I = V_{IH}$ | 1.65 V | 1.65 V | 1.2 | | | V |
| | | $I_{OH} = -8 \text{ mA}$ | | 2.3 V | 2.3 V | 1.75 | | | |
| | | $I_{OH} = -16 \text{ mA}$ | | 3 V | 3 V | 2.1 | | | |
| | | I _{OL} = 100 μA | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | 0.2 | |
| | | I _{OL} = 1 mA | | 1.2 V | 1.2 V | | 0.07 | | |
| | _ | I _{OL} = 2 mA | ., ., | 1.4 V | 1.4 V | | | 0.35 | |
| V_{OL} | B port | I _{OL} = 4 mA | $V_I = V_{IL}$ | 1.65 V | 1.65 V | | | 0.45 | V |
| | | I _{OL} = 8 mA | | 2.3 V | 2.3 V | | | 0.55 | |
| | | I _{OL} = 16 mA | | 3 V | 3 V | | | 0.79 | |
| l _l | Control inputs | V _I = V _{CCA} or GND | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | ±1 | μΑ |
| I _{OZ} ⁽⁴⁾ | A or B port | $V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND | See function table for input states when outputs are Hi Z | 3.6 V | 3.6 V | | | ±5 | μΑ |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | 10 | |
| I _{CCA} | | $V_I = V_{CCI}$ or GND, | I _O = 0 | 3.6 V | 0 V | | | 10 | μΑ |
| | | | | 0 V | 3.6 V | | | -1 | |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | 10 | |
| I _{CCB} | | $V_I = V_{CCI}$ or GND, | $I_O = 0$ | 3.6 V | 0 V | | | -1 | μΑ |
| | | | | 0 V | 3.6 V | | | 10 | |
| I _{CCA} + | I _{CCB} | $V_I = V_{CCI}$ or GND, | I _O = 0 | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | 15 | μΑ |
| | Control | | | | | | 1.5 | 2 | |
| Ci | inputs | $V_I = V_{CCA}$ or GND | | 1.8 V | 3 V | | | | pF |
| | Clock input | | | | | | 1.5 | 2 | |
| C _{io} | A port | $V_O = V_{CCA}$ or GND | | 1.8 V | 3 V | | 2.5 | 3.5 | pF |
| - 10 | B port | $V_O = V_{CCB}$ or GND | | 1.5 V | | | 12 | 14 | ۲ı |

 $[\]begin{array}{ll} \hbox{(1)} & V_{CCO} \text{ is the } V_{CC} \text{ associated with the output port.} \\ \hbox{(2)} & V_{CCI} \text{ is the } V_{CC} \text{ associated with the data input port.} \\ \hbox{(3)} & \text{All typical values are at } T_A = 25^{\circ}\text{C.} \\ \hbox{(4)} & \text{For I/O ports, the parameter } I_{OZ} \text{ includes the input leakage current.} \\ \end{array}$



OUTPUT SLEW RATES

over recommended operating free-air temperature range (unless otherwise noted)(1)

| PARAMETER | FROM | то | $V_{CCA} = 1.8 \text{ V} \pm 0.00$ $V_{CCB} = 3 \text{ V} \pm 0.00$ | .15 V, .3 V | UNIT |
|----------------|------|-----|--|--------------------|------|
| | | | MIN | MAX | |
| t _r | 20% | 80% | | 2.7 ⁽²⁾ | ns |
| t _f | 80% | 20% | | 2.5 ⁽²⁾ | ns |

- (1) Values are characterized, but not production tested.
- (2) Using $C_L = 30 \text{ pF}$ on the B side and $C_L = 7 \text{ pF}$ on the A side

TYPICAL SWITCHING CHARACTERISTICS

 $T_A = 25$ °C, $V_{CCA} = 1.2$ V (see Figure 6)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = 1.5 V | V _{CCB} = 1.8 V | V _{CCB} = 2.5 V | V _{CCB} = 3 V | UNIT |
|---------------------------------|---------|-------------|--------------------------|--------------------------|--------------------------|--------------------------|------------------------|------|
| | (INPUT) | (OUTPUT) | TYP | TYP | TYP | TYP | TYP | |
| | Α | В | 4.9 | 4 | 3.5 | 3.2 | 3.2 | |
| | В | А | 5.3 | 4.3 | 4.1 | 3.9 | 3.9 | |
| | CLKA | CLKB | 5.1 | 4 | 3.5 | 3.1 | 3.1 | |
| t _{pd} | CLKA | CLK-f | 10.3 | 8.9 | 7.7 | 7.7 | 7.7 | ns |
| | CMDA | CMDB | 4.9 | 4 | 3.5 | 3.2 | 3.2 | |
| | CMDB | CMDA | 4.8 | 4.4 | 4.2 | 4 | 4 | |
| t _{en} ⁽¹⁾ | DIR | А | 5.3 | 5.4 | 5.2 | 6 | 5.9 | ns |
| t _{dis} ⁽¹⁾ | DIR | A | 5.5 | 5.4 | 5.5 | 5.6 | 5.5 | ns |

⁽¹⁾ DIR refers to CMD-dir, DAT0-dir, and DAT123-dir.

SWITCHING CHARACTERISTICS V_{CCA} = 1.5 V ± 0.1 V

over recommended operating free-air temperature range (see Figure 6)

| PARAMETER | FROM (INPUT) | TO | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | V _{CCB} = ± 0.3 | | UNIT |
|---------------------------------|-----------------|----------|--------------------------|------|--------------------------|------|--------------------------|------|--------------------------|------|--------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | |
| | Α | В | 1.2 | 7.2 | 0.8 | 6.3 | 0.8 | 5.4 | 0.9 | 5.1 | 0.9 | 5.1 | |
| | В | Α | 1.1 | 6.2 | 1 | 7.2 | 0.93 | 6.6 | 0.45 | 7 | 0.45 | 7 | |
| | CLKA | CLKB | 1.4 | 7.1 | 1.1 | 6.2 | 0.8 | 5.3 | 0.7 | 5.1 | 0.7 | 5.1 | 20 |
| t _{pd} | CLKA | CLK-f | 1.1 | 12.7 | 1.3 | 13.3 | 1.3 | 10.6 | 1.9 | 10.9 | 1.9 | 10.9 | ns |
| | CMDA | CMDB | 1.1 | 6 | 0.9 | 5.6 | 0.7 | 4.7 | 0.6 | 4.1 | 0.6 | 4.1 | |
| | CMDB | CMDA | 0.8 | 5.9 | 0.8 | 6.8 | 0.8 | 6.4 | 0.1 | 6.7 | 0.1 | 6.7 | |
| t _{en} ⁽¹⁾ | DIR | А | 1.0 | 9.1 | 1.1 | 10.3 | 1.1 | 8.7 | 1.1 | 11 | 1.1 | 11 | ns |
| t _{dis} ⁽¹⁾ | DIR | А | 1.1 | 8.1 | 1.1 | 8.3 | 1.1 | 8.3 | 1.1 | 8.3 | 1.1 | 8.3 | ns |

(1) DIR refers to CMD-dir, DAT0-dir, and DAT123-dir.

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SWITCHING CHARACTERISTICS $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$

over recommended operating free-air temperature range (see Figure 6)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = 1 ± 0.15 | | V _{CCB} = : ± 0.2 | | V _{CCB} = ± 0.3 | | V _{CCB} = 3 ± 0.3 | | UNIT |
|---------------------------------|---------|-------------|--------------------------------|-----|-------------------------------|-----|--------------------------|-----|-------------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 0.7 | 5.8 | 0.6 | 4.9 | 0.5 | 4.7 | 0.5 | 4.7 | |
| | В | Α | 0.7 | 4.9 | 0.7 | 4.5 | 0.2 | 5.2 | 0.2 | 5.2 | |
| | CLKA | CLKB | 0.9 | 5.8 | 0.6 | 4.9 | 0.6 | 4.7 | 0.6 | 4.7 | |
| t _{pd} | CLKA | CLK-f | 0.9 | 11 | 0.9 | 9.2 | 0.8 | 8.8 | 0.8 | 8.8 | ns |
| | CMDA | CMDB | 0.7 | 4.3 | 0.5 | 4.1 | 0.5 | 3.4 | 0.5 | 3.4 | |
| | CMDB | CMDA | 0.7 | 4.6 | 0.8 | 4.2 | 0.1 | 5 | 0.1 | 5 | |
| t _{en} ⁽¹⁾ | DIR | Α | 0.7 | 7.2 | 0.7 | 6.6 | 0.7 | 7.8 | 0.7 | 7.8 | ns |
| t _{dis} ⁽¹⁾ | DIR | А | 1.0 | 7.9 | 1 | 7.7 | 1 | 8.2 | 1 | 8.2 | ns |

⁽¹⁾ DIR refers to CMD-dir, DAT0-dir, and DAT123-dir.

SWITCHING CHARACTERISTICS

 $V_{CCA} = 2.5 V \pm 0.2 V$

over recommended operating free-air temperature range(see Figure 6)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | | V _{CCB} = 3 ± 0.3 | | UNIT |
|--------------------------------|---------|-------------|-------------------------------|-----|--------------------------|-----|-------------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 0.5 | 4.3 | 0.4 | 4.1 | 0.4 | 4.1 | |
| | В | Α | 0.5 | 3.5 | 0.2 | 3.7 | 0.2 | 3.7 | |
| | OLIKA | CLKB | 0.5 | 4.3 | 0.4 | 4.1 | 0.4 | 4.1 | |
| t _{pd} | CLKA | CLK-f | 0.4 | 7.8 | 0.3 | 7.3 | 0.3 | 7.3 | ns |
| | CMDA | CMDB | 0.3 | 3 | 0.3 | 2.7 | 0.3 | 2.7 | |
| | CMDB | CMDA | 0.7 | 3 | 0.2 | 3.4 | 0.2 | 3.4 | |
| t _{en} ⁽¹⁾ | DIR | А | 0.5 | 5.1 | 0.5 | 5.6 | 0.5 | 5.6 | ns |
| t _{dis} (1) | DIR | А | 0.7 | 5.7 | 0.7 | 6.7 | 0.7 | 6.7 | ns |

⁽¹⁾ DIR refers to CMD-dir, DAT0-dir, and DAT123-dir.

SWITCHING CHARACTERISTICS V_{CCA} = 3.3 V ± 0.3 V

over recommended operating free-air temperature range (see Figure 6)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = 3 ± 0.3 V | | V _{CCB} = 3.3 ± 0.3 V | V | UNIT |
|--------------------------------|---------|-------------|---------------------------------|-----|-----------------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | |
| | Α | В | 0.3 | 3.8 | 0.3 | 3.8 | |
| | В | Α | 0.3 | 3 | 0.3 | 3 | |
| | CLKA | CLKB | 0.3 | 3.8 | 0.3 | 3.8 | |
| t _{pd} | CLKA | CLK-f | 0.1 | 6.7 | 0.1 | 6.7 | ns |
| | CMDA | CMDB | 0.2 | 2.5 | 0.2 | 2.5 | |
| | CMDB | CMDA | 0.4 | 2.6 | 0.4 | 2.6 | |
| t _{en} ⁽¹⁾ | DIR | Α | 0.3 | 4.5 | 0.3 | 4.5 | ns |
| t _{dis} (1) | DIR | Α | 0.9 | 7.9 | 0.9 | 7.9 | ns |

⁽¹⁾ DIR refers to CMD-dir, DAT0-dir, and DAT123-dir.

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TYPICAL FREQUENCY AND OUTPUT SKEW

 $T_A = 25$ °C, $V_{CCA} = 1.2$ V (see Figure 6)

| PA | RAMETER | FROM (INPUT | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = 1.5 V | V _{CCB} = 1.8 V | V _{CCB} = 2.5 | V _{CCB} = 3 V | V _{CCB} = 3.3 | UNIT |
|--------------------|------------------------|----------------|----------------|--------------------------|-----------------------------|--------------------------|------------------------|------------------------|------------------------|-------|
| | |) | (OUIFUI) | TYP | TYP | TYP | TYP | TYP | TYP | |
| | Clock | CLKA | CLKB | 95 | 95 | 95 | 95 | 95 | 95 | |
| | CIOCK | CLKA | CLK-f | 95 | 95 | 95 | 95 | 95 | 95 | MHz |
| t _{max} | Data | Α | В | 95 | 95 | 95 | 95 | 95 | 95 | IVITZ |
| | Dala | В | А | 95 | 95 | 95 | 95 | 95 | 95 | |
| t _{sk(o)} | Channel-to- channel | А | В | 0.1 | 0.1 | 0.1 | 0.3 | 0.2 | | ns |

MAXIMUM FREQUENCY AND OUTPUT SKEW V_{CCA} = 1.5 V ± 0.1 V

over recommended operating free-air temperature range (see Figure 6)

| PA | PARAMETER FROM (INPUT) | | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | V _{CCB} = ± 0.3 | | UNIT |
|--------------------|------------------------|---------|----------------|--------------------------|-----|--------------------------|-----|--------------------------|-----|--------------------------|-----|--------------------------|-----|---------|
| | | (INFUT) | (OUTPUT) | MIN | MAX | |
| | Clock | CLKA | CLKB | 95 | | 95 | | 95 | | 95 | | 95 | | |
| | Clock | CLKA | CLK-f | 95 | | 95 | | 95 | | 95 | | 95 | | N 41 1- |
| t _{max} | Doto | Α | В | 95 | | 95 | | 95 | | 95 | | 95 | | MHz |
| | Data | В | А | 95 | | 95 | | 95 | | 95 | | 95 | | |
| t _{sk(o)} | Channel-to- channel | Α | В | | 0.1 | | 0.1 | | 0.1 | | 0.1 | | | ns |

MAXIMUM FREQUENCY AND OUTPUT SKEW $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$

over recommended operating free-air temperature range (see Figure 6)

| PA | ARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1 ± 0.15 | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | 3 V V | V _{CCB} = 3 ± 0.3 | | UNIT |
|--------------------|------------------------|-----------------|-------------|--------------------------------|-----|-------------------------------|-----|--------------------------|----------|-------------------------------|-----|--------|
| | | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Clock | CLKA | CLKB | 95 | | 95 | | 95 | | 95 | | |
| | Clock | CLKA | CLK-f | 95 | | 95 | | 95 | | 95 | | NAL 1- |
| f _{max} | Data | А | В | 95 | | 95 | | 95 | | 95 | | MHz |
| | Data | В | А | 95 | | 95 | | 95 | | 95 | | |
| t _{sk(o)} | Channel-to- channel | Α | В | | 0.1 | | 0.2 | | 0.2 | | | ns |



MAXIMUM FREQUENCY AND OUTPUT SKEW V_{CCA} = 2.5 V ± 0.2 V

over recommended operating free-air temperature range (see Figure 6)

| | PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = 2. ± 0.2 \ | | V _{CCB} = 3 V ± 0.3 V | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT |
|--------------------|------------------------|---------|-------------|----------------------------------|-----|-----------------------------------|-----|-------------------------------------|-----|--------|
| | | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Clock | CLKA | CLKB | 95 | | 95 | | 95 | | |
| £ | CIOCK | CLNA | CLK-f | 95 | | 95 | | 95 | | MHz |
| Imax | Doto | Α | В | 95 | | 95 | | 95 | | IVITIZ |
| | Data | В | А | 95 | | 95 | | 95 | | |
| t _{sk(o)} | Channel-to- channel | А | В | | 0.1 | | 0.3 | | 0.3 | ns |

MAXIMUM FREQUENCY AND OUTPUT SKEW

 $V_{CCA} = 3.3 V \pm 0.3 V$

over recommended operating free-air temperature range (see Figure 6)

| PA | RAMETER | FROM | TO (OUTPUT) | V _{CCB} = 3 V ± 0.3 V | ٧ | V _{CCB} = 3.3 V ± 0.3 V | | UNIT |
|--------------------|------------------------|---------|-------------|-----------------------------------|-----|-------------------------------------|-----|-------|
| | | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | |
| | Clock | CLKA | CLKB | 95 | | 95 | | |
| | Clock | CLKA | CLK-f | 95 | | 95 | | MHz |
| I _{max} | Data | Α | В | 95 | | 95 | | IVI□Z |
| | Data | В | Α | 95 | | 95 | | |
| t _{sk(o)} | Channel-to- channel | А | В | | 0.3 | | | ns |

OPERATING CHARACTERISTICS

 $T_A = 25^{\circ}C$

| PARA | METER | TEST CONDITIONS | V _{CCA} = V _{CCB} = 1.2 V | $V_{CCA} = V_{CCB} = 1.5 V$ | $V_{CCA} = V_{CCB} = 1.8 V$ | $V_{CCA} = V_{CCB} = 2.5 V$ | V _{CCA} = V _{CCB} = 3 V | $V_{CCA} = V_{CCB} = 3.3 V$ | UNIT |
|---------------------------------|--------------------------------------|------------------------------------|---|-----------------------------|-----------------------------|-----------------------------|---|-----------------------------|------|
| C _{pdA} ⁽¹⁾ | A-port input, B-port output | C _L = 0, f = 10 MHz, | 4.5 | 4.7 | 4.9 | 5.5 | 6 | 6.4 | pF |
| | B-port input, A-port output | $t_r = t_f = 1 \text{ ns}$ | 8 | 8.3 | 8.5 | 9.1 | 9.5 | 9.7 | рг |
| C (1) | A-port input, B-port output | $C_{L} = 0,$ f = 10 MHz, | 27.9 | 27.8 | 27.7 | 27.6 | 27.6 | 27.5 | n= |
| C _{pdB} ⁽¹⁾ | B-port input, A-port output | $t_r = t_f = 1 \text{ ns}$ | 2.6 | 2.5 | 2.4 | 2.3 | 1.8 | 1.8 | pF |

⁽¹⁾ Power dissipation capacitance per transceiver



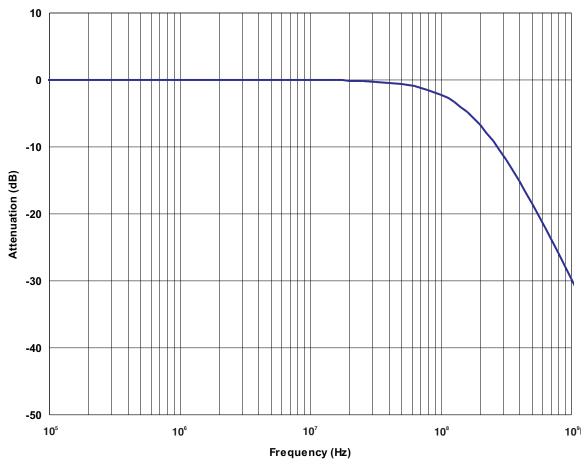
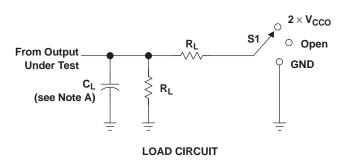


Figure 5. Typical ASIP EMI Filter Frequency Response

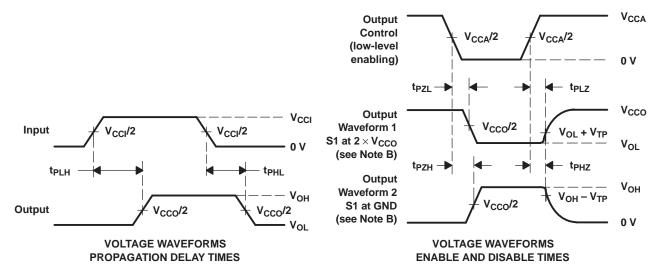


PARAMETER MEASUREMENT INFORMATION



| TEST | S1 |
|------------------------------------|--------------------|
| t _{pd} | Open |
| t _{PLZ} /t _{PZL} | 2×V _{CCO} |
| t _{PHZ} /t _{PZH} | GND |

| V _{CCO} | CL | R _L | V _{TP} |
|--------------------|-------|----------------|-----------------|
| 1.5 V \pm 0.1 V | 15 pF | 2 k Ω | 0.1 V |
| 1.8 V \pm 0.15 V | 15 pF | 2 k Ω | 0.15 V |
| 2.5 V \pm 0.2 V | 15 pF | 2 k Ω | 0.15 V |
| 3.3 V \pm 0.3 V | 15 pF | 2 k Ω | 0.3 V |



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \Omega$, $dv/dt \geq 1 V/ns$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
 - F. t_{PZL} and t_{PZH} are the same as t_{en}.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.

Figure 6. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM

31-Dec-2019

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | _ | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|---------|----------------------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| SN74AVCA406EZQSR | LIFEBUY | BGA MICROSTAR JUNIOR | ZQS | 24 | 2500 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | WM406E | |
| SN74AVCA406EZXYR | LIFEBUY | BGA MICROSTAR JUNIOR | ZXY | 20 | 2500 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | WM406E | |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

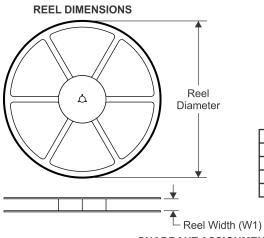
31-Dec-2019

| In no event shall TI's liabili | ity arising out of such information exceed the to | tal purchase price of the TI part(s | s) at issue in this document sold by | VII to Customer on an annual basis. |
|--------------------------------|---|-------------------------------------|---|-------------------------------------|
| | | | | |

PACKAGE MATERIALS INFORMATION

www.ti.com 19-Feb-2020

TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|----------------------------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AVCA406EZQSR | BGA MI CROSTA R JUNI OR | ZQS | 24 | 2500 | 330.0 | 12.4 | 3.3 | 3.3 | 1.6 | 8.0 | 12.0 | Q1 |
| SN74AVCA406EZXYR | BGA MI CROSTA R JUNI OR | ZXY | 20 | 2500 | 330.0 | 12.4 | 2.75 | 3.45 | 1.05 | 4.0 | 12.0 | Q2 |

PACKAGE MATERIALS INFORMATION

www.ti.com 19-Feb-2020

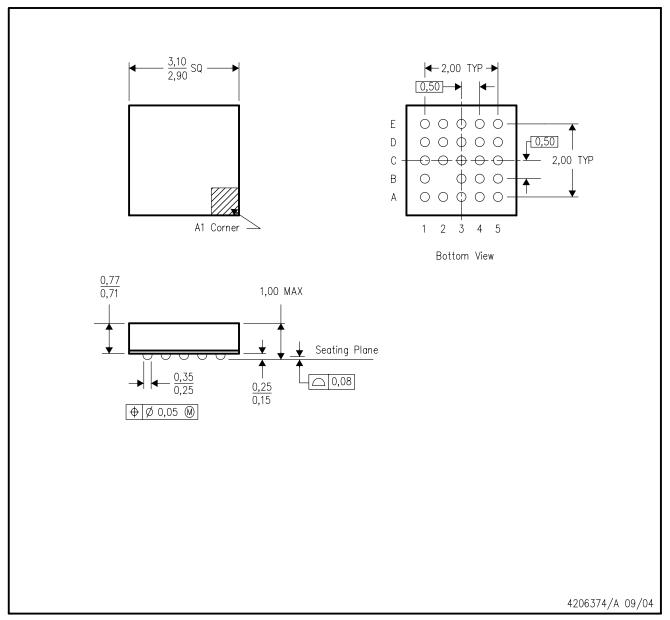


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|-------------------------|-----------------|------|------|-------------|------------|-------------|
| SN74AVCA406EZQSR | BGA MICROSTAR JUNIOR | ZQS | 24 | 2500 | 350.0 | 350.0 | 43.0 |
| SN74AVCA406EZXYR | BGA MICROSTAR JUNIOR | ZXY | 20 | 2500 | 350.0 | 350.0 | 43.0 |

ZQS (S-PBGA-N24)

PLASTIC BALL GRID ARRAY



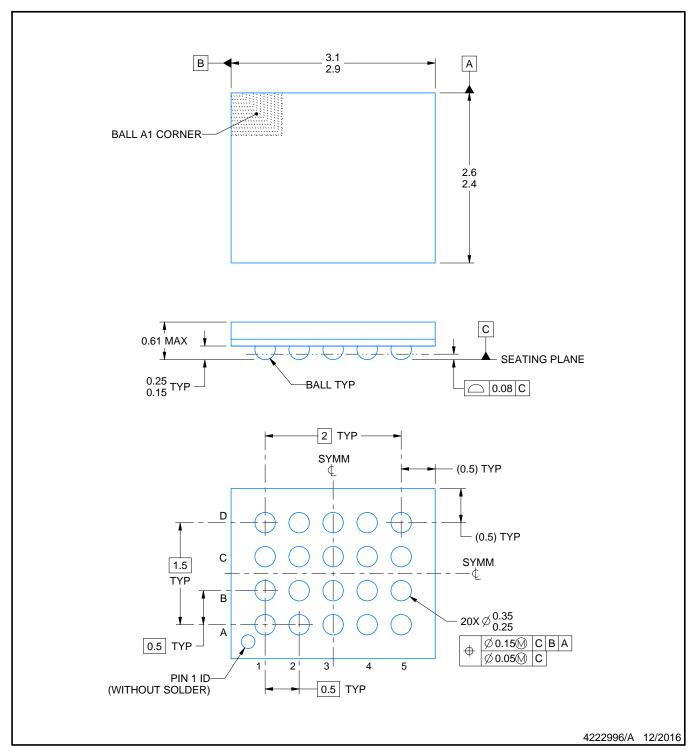
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225
- D. This package is lead-free.





PLASTIC BALL GRID ARRAY



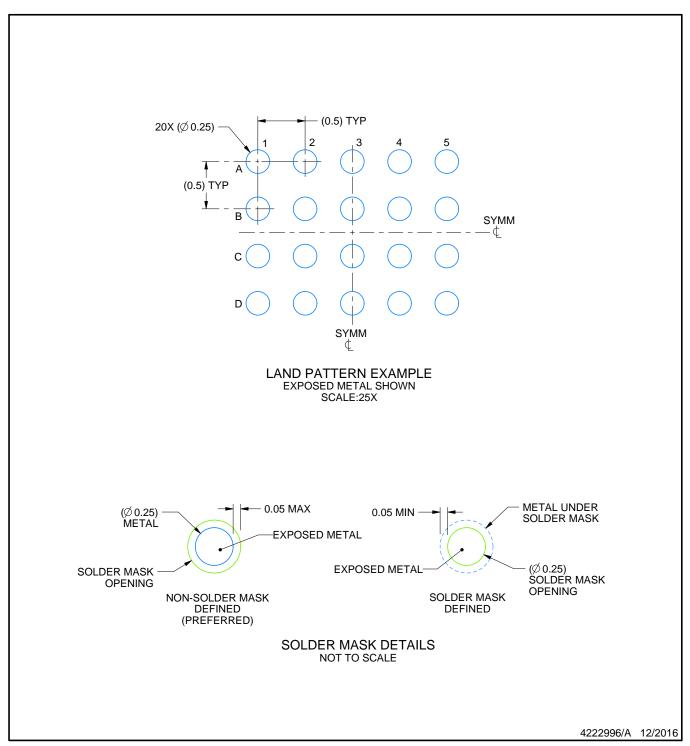
NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.



PLASTIC BALL GRID ARRAY

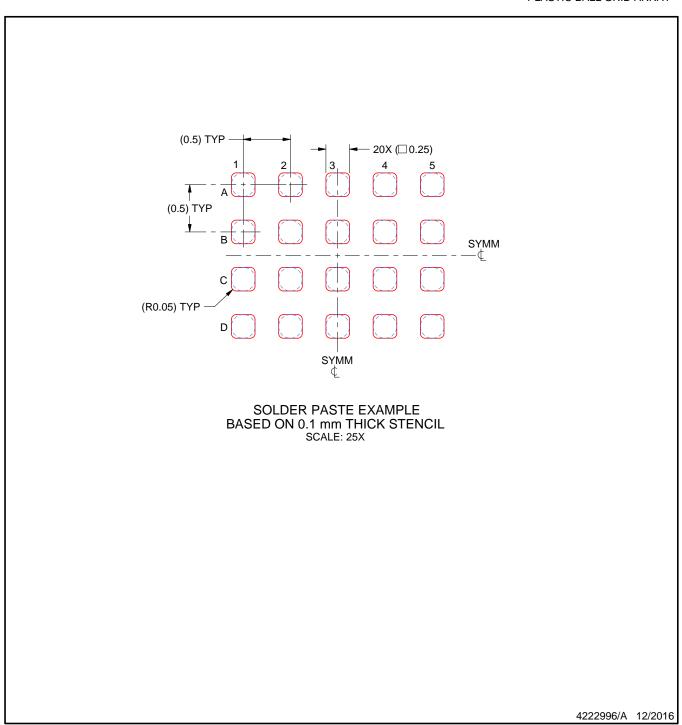


NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 (www.ti.com/lit/spraa99).



PLASTIC BALL GRID ARRAY



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



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